

# 4th Industry Roundtable on Semiconductor Metrology & Inspection

*Your Challenges, Pain-Points & Developing a Swiss-Specific Roadmap*

## EVENT DETAILS

**Date:** Wednesday 24th June 2026  
**Time:** 13:00 – 18:00  
**Address:** Park Innovaare | Parkstrasse 1, 5234 Villigen, Switzerland  
**Room:** Curie 1 & 2 Event Room (Building A1, Floor 1)

## ABOUT THIS EVENT

The **4th Industry Roundtable** hosted by the SeMI Innovation Hub is a half-day event bringing together industry and technology experts in semiconductor metrology and inspection. Through structured sessions, we aim to:

- **Identify** the most pressing challenges and pain-points facing the industry in semiconductor metrology & inspection
- **Facilitate** discussions across participants, with the goal of scoping and developing project ideas that address these challenges and pain-points
- **Build** a Switzerland-specific innovation roadmap that reflects real industry needs, ranking projects by priority and the timeline in which they should be realised
- **Explore** how the SeMI Innovation Hub can support the realisation of these projects, including what exploratory / feasibility work can be undertaken to lay the groundwork

## PROGRAMME

TIME	SESSION <i>(refreshments available throughout the day)</i>
13:00 - 13:30	<b>Arrival &amp; Welcome Coffee</b>
13:30 - 13:50	<b>Welcome, Introduction &amp; SeMI Hub Status Update</b> Opening remarks from the SeMI Innovation Hub, overview of the day's agenda and a brief update on SeMI Hub activities, partnerships and milestones.
13:50 - 14:50	<b>Session 1 - Industry Challenge Presentations</b> Pre-submitted challenges are presented in thematic clusters, followed by open discussion (~15 min per cluster). All participants are encouraged to engage. Additional challenges not pre-submitted may also be raised if there is sufficient interest / time.
14:50 - 15:50	<b>Session 2 - Thematic Roundtable Discussions</b> Participants divide into small groups organised by challenge cluster. Facilitated deep dive on goals, project feasibility, required resources and potential collaboration opportunities. Projects may be structured in phases, moving from an initial feasibility study to implementation milestones.
15:50 - 16:05	<b>Coffee Break</b>
16:05 - 16:50	<b>Session 3 - Building a Swiss Roadmap Workshop</b> Identified challenges and projects are mapped to the SeMI Innovation Roadmap. Participants then collectively vote to rank initiatives by priority and impact for Swiss industry.

<p><b>16:50 - 17:20</b></p>	<p><b>Session 4 - From Roadmap to Action</b> A collaborative review of the draft innovation roadmap, incorporating outputs from the roundtable discussions. Together, next steps and key follow-up actions are defined going forward.</p>
<p><b>17:20 - 17:30</b></p>	<p><b>Closing Remarks &amp; Summary</b> Summary of outcomes and key takeaways. Closing remarks from the SeMI Hub team.</p>
<p><b>17:30 - 18:00</b></p>	<p><b>Networking Apero</b></p>

## SUBMIT YOUR CHALLENGES & FEEDBACK NOW

To make the most of our time together, we kindly ask all participating organisations to **submit your key challenges & pain-points in semiconductor metrology and inspection ahead of the event.** This allows us to organise discussions into meaningful thematic clusters and ensure your voice is represented.

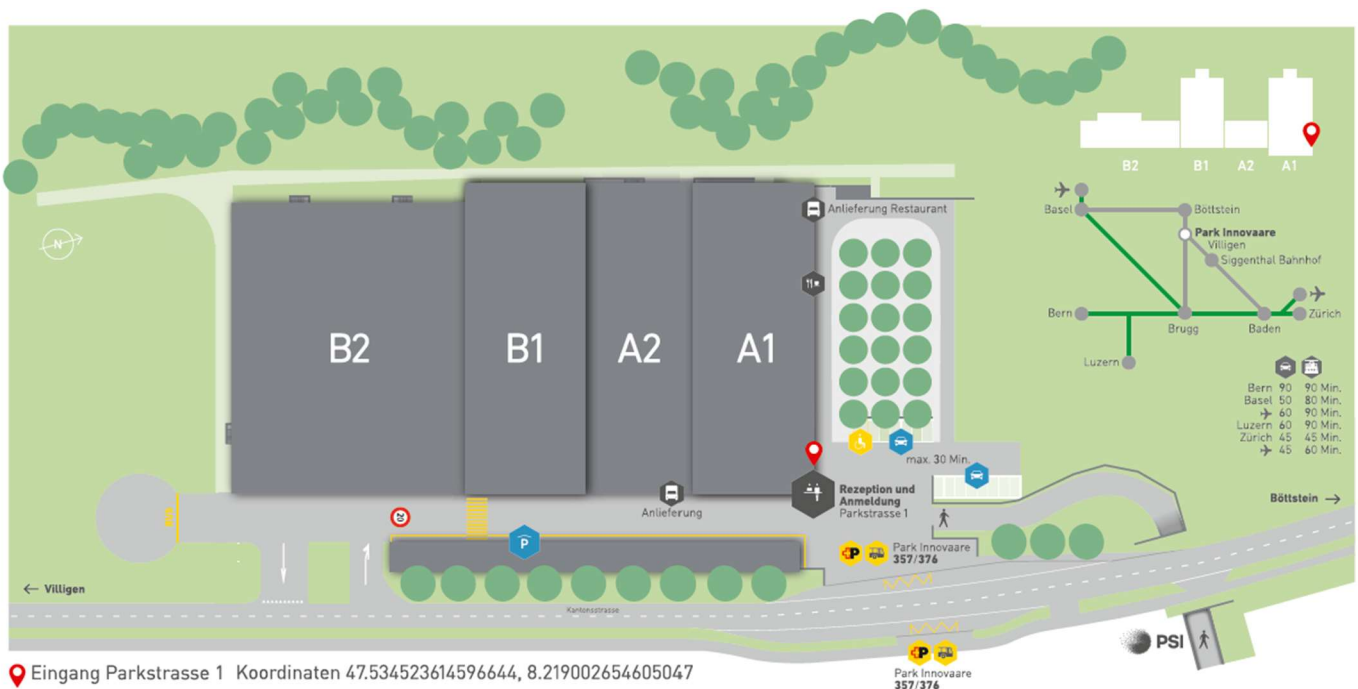
Please **send your submissions by email** to: [semihub@parkinnovaare.ch](mailto:semihub@parkinnovaare.ch) by **Friday 19 June 2026.**

When submitting, please include the following:

- *Your company / organisation name*
- *A brief description of your key challenge(s) / pain-point(s)*
- *Any specific topics or questions you would like to raise during the roundtable*

## LOCATION & GETTING TO THE EVENT

Park Innovaare | Parkstrasse 1, 5234 Villigen, Switzerland



*We look forward to welcoming you!*

